

# Model Name: P430QVN02.0

Issue Date: 2019/04/08

(\*) Preliminary Specifications (\*) Final Specifications

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# Contents

	General	Description	_
1.1.	Displa	y Characteristics	4
1.2.	Optica	al Characteristics	5
1.3.	Mech	anical Characteristics	8
		Placement Suggestions	
2.	Absolute	Maximum Ratings 1	2
3.	Electrica	I Specification 1	3
		ical Characteristics 1	
	3.1.1.	DC Characteristics (Ta = 25 $\pm$ 2 $^{\circ}$ C)	13
		AC Characteristics (Ta = 25 $\pm$ 2 °C)	
	3.1.3.	Driver Characteristics	14
		TCON Characteristics	
3.2.	Interfa	ce Connections1	8
3.3.	Signa	Timing Specification2	21
3.4.	Color	Input Data Reference2	22
3.5.	Powe	Sequence for LCD	23
3.6.	Backli	ght Specification2	24
		Electrical specification (Ta = 25 ± 2 °C)	
		Input Pin Assignment	
		Power Sequence for Backlight	
		LED Operating Life Time	
		y Test Items	8
5.	Internati		
		onal Standard2	
	Safety	/	29
5.2.	Safety	/	29
5.2. 6.	Safety EMC Packing	/	29
5.2. 6.1.	Safety EMC Packing Defini	/	29 30
5.2. 6.1. 6.2.	Safety EMC Packing Packin	/	29 30 31
5.2. 6.1. 6.3.	Safety EMC Packing Packin	tion of Label	29 30 31 32
5.2. 6.1. 6.3. 7.	Safety EMC Packing Packing Pallet Precauti	tion of Label	30
5.2. 6.1. 6.3. 7.1.	Safety EMC Packing Defini Pallet Precauti	tion of Label	30
5.2. 6.1. 6.3. 7.1.	Safety EMC Packing Defini Pallet Precauti	tion of Label	30
5.2. 6.1. 6.3. 7.1. 7.2. 7.3.	Safety EMC Packing Defini Packing Pallet Mount Opera	tion of Label	30 30 33 33 33 34
5.2. 6.3. 7.1. 7.2. 7.3.	Safety EMC Packing Defini Packing Pallet Mount Opera Opera Electr	tion of Label	39 30 31 32 33 34 34
5.2. 6.3. 7.1. 7.2. 7.3.	Safety EMC Packing Defini Packing Pallet Mount Opera Opera Electr	tion of Label	39 30 31 32 33 34 34
5.2. 6.1. 6.3. 7.1. 7.2. 7.3.	Safety EMC Packing Defini Packing Pallet Precauti Mount Opera Opera Electr Preca	tion of Label	39 30 31 32 33 34 34



# Record of Revision

Version	Date	Page	Description
0.0	2016/06/21		1 <sup>st</sup> release
		13	Modify "DC Characteristics" table
4.0	2040/00/00	14	Modify "AC Characteristics" table
1.0	2016/08/29	15	Modify "Note2. test condition"
		24	Modify" Power Sequence for LCD"
1.1	2016/12/19	35	Add item (2) in "Precautions for Strong Light Exposure"
2.0	2017/02/06	4	Modify "Surface Treatment Note" Haze = 11% → Haze = 44%
	2017/02/06	8	Modify "Depth (Dmax)" 25.2 → 26.9mm
	2017/02/06	8	Modify "Weight" 9000 → 10640g
2.1	2017/06/13	4	Modify "Outline Dimension" 963.7(H) x 552.0(V) x 25.2(D) → 26.9(D)
	2017/06/13	4	Modify "Bezel Opening" 954.8(H) x 543.1(V) → 945.9(H) x 534.2(V)
	2017/06/13	29	Modify " Shock test" 50G ,20ms ±X,Y,Z axis → 50G ,11ms ±X,Y,Z axis
2.2	2017/10/31	9	Modify 2D drawing
		10	Modify 2D drawing
		11	Modify 2D drawing
2.3	2018/11/6	25	Modify "Inrush Current" and "External PWM Frequency"
2.4	2019/4/3	4	Correct "General Description"
		11	Modify "Note2 A17~A18 M4 user hole"
2.5	2019/4/8	34	Operating Condition for Public Information Display
	10	31,32	Packing Methods
		1000	



# 1. General Description

This specification applies to the 43 inch Color TFT-LCD Module P430QVN02.0. This LCD module has a TFT active matrix type liquid crystal panel 3840x2160 pixels, and diagonal size of 42.5 inch. This module supports 3840x2160 mode. Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the brightness of the sub-pixel color is determined with 10-bits gray scale signal for each dot.

The P430QVN02.0 has been designed to apply the V by one interface method. It is intended to support displays where high brightness, wide viewing angle.

#### \* General Information

## 1.1. <u>Display Characteristics</u>

Items	Specification	Unit	Note
Active Screen Size	42.5	inch	
Display Area	941.184 (H) x 529.416 (V)	mm	
Outline Dimension	963.7(H) x 552.0(V) x26.9(D)	mm	D: front bezel to DB cover
Driver Element	a-Si TFT active matrix		
Bezel Opening	945.9(H) x 534.2(V)	mm	
Display Colors	10bit	Colors	
Number of Pixels	3,840x2,160	Pixel	
Pixel Pitch	0.2451 (H) x 0.2451 (W)	mm	
Pixel Arrangement	RGB vertical stripe		
Display Operation Mode	Normally Black		
Surface Treatment	Anti-Glare, 3H		Haze = 44%
Rotate Function	Unachievable		Note 1
Display Orientation	Portrait/Landscape Enabled		Note 2

Note 1: Rotate Function refers to LCD display could be able to rotate. This function does not work in this model.

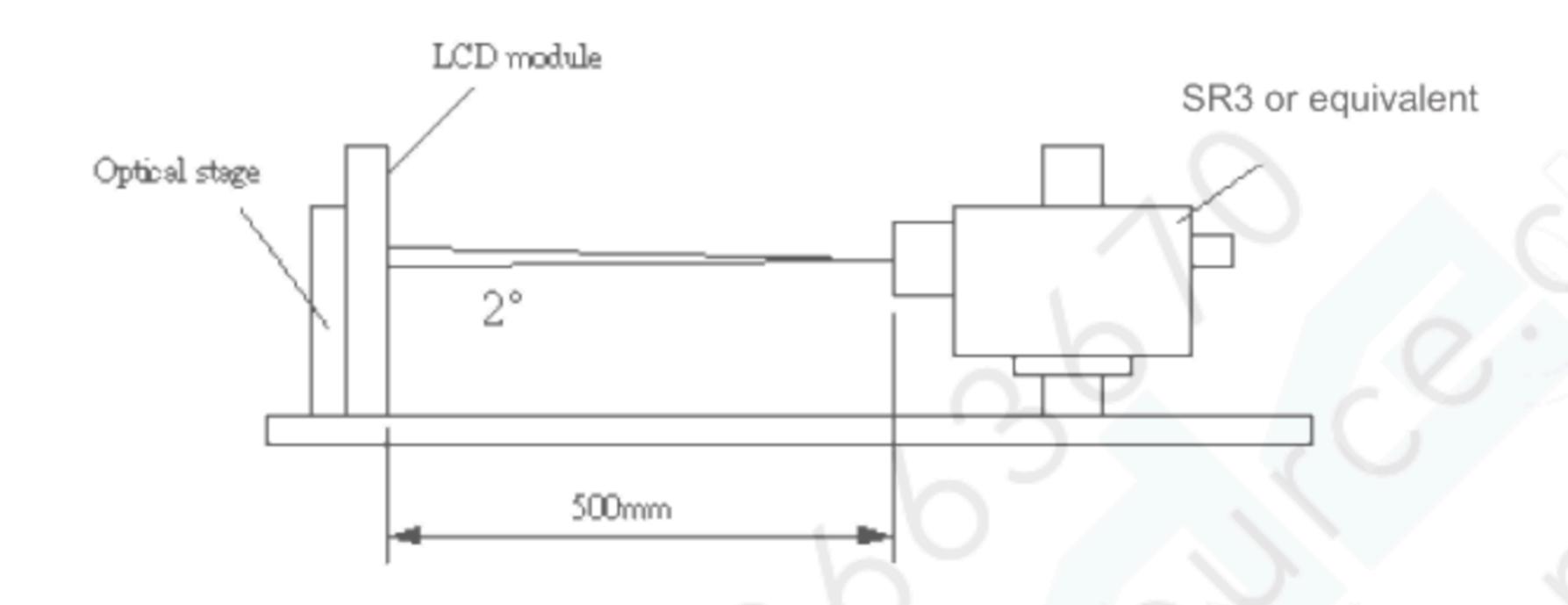
Note 2: Please refer to 5.1 Placement Suggestions.



# 1.2. Optical Characteristics

Optical characteristics are determined on the back-light of measured unit is 'ON' and stabilized after 45~60 minutes in a dark environment at 25°C. The values are specified at 50cm distance from the LCD surface at a viewing angle of  $\varphi$  and  $\theta$  equal to 0°.

Fig.1 presents additional information concerning the measurement equipment and method.



	D	0		Values		1124	N1 - 4 -
	Parameter	Symbol	Min.	Тур.	Max	Unit	Notes
Contrast	Ratio	CR	2400	3000			1
Surface I	Luminance (White)	L <sub>WH</sub> (2D)	560	700		cd/m²	2
Luminan	ce Variation	δwHITE(9P)			1.33		3
Respons	e Time (G to G)	Тγ		8	10	ms	4
Color Ga	mut	NTSC		72		%	
	ordinates						
	Red	R <sub>x</sub>		0.650			
		R <sub>Y</sub>		0.336			
	Green	Gx		0.310			
		GY	T 0.02	0.611	T 10.02		
	Blue	Вх		0.150	Typ.+0.03		
		B <sub>Y</sub>		0.067			
	White	W <sub>X</sub>		0.28			
		W <sub>Y</sub>		0.29			
Viewing							5
	x axis, right(φ=0°)	$\theta_{\rm r}$		89		degree	
	x axis, left(φ=180°)	θι		89		degree	
	y axis, up(φ=90°)	θυ		89		degree	
	y axis, down (φ=270°)	$\theta_{d}$		89		degree	

#### Note:

1. Contrast Ratio (CR) is defined mathematically as:

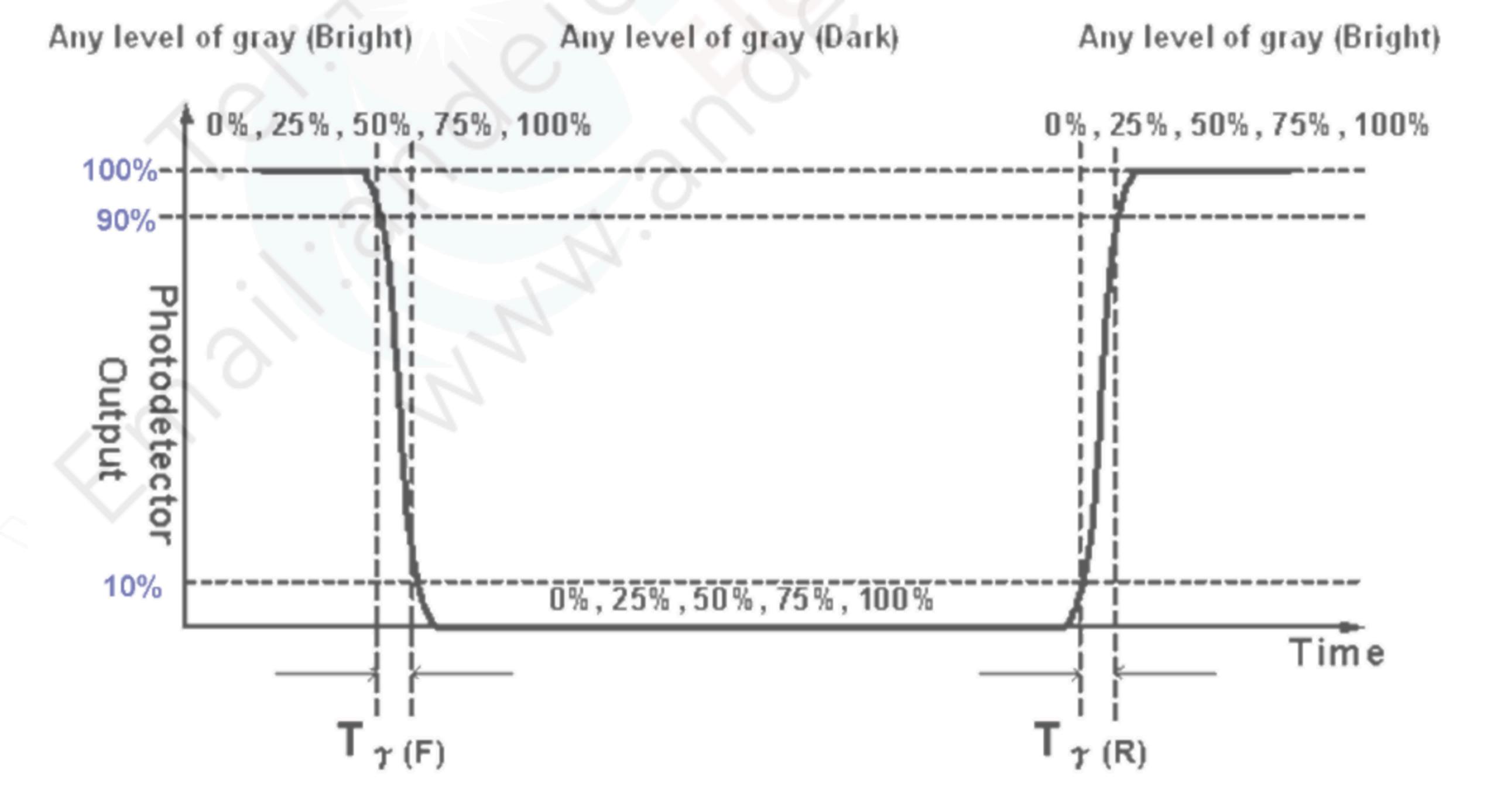


# Contrast Ratio= Surface Luminance of Lons Surface Luminance of Loffs

- 2. Surface luminance is luminance value at point 5 across the LCD surface 50cm from the surface with all pixels displaying white. From more information see FIG 2. LED current I<sub>F</sub> = typical value (without driver board), LED input VDDB =24V, I<sub>DDB</sub>. = Typical value (with driver board), L<sub>WH</sub>=Lon5 where Lon5 is the luminance with all pixels displaying white at center 5 location.
- 3. The variation in surface luminance, δWHITE is defined (center of Screen) as: δ<sub>WHITE(9P)</sub>= Maximum(L<sub>on1</sub>, L<sub>on2</sub>,...,L<sub>on9</sub>)/ Minimum(L<sub>on1</sub>, L<sub>on2</sub>,...L<sub>on9</sub>)
- 4. Response time  $T_{\gamma}$  is the average time required for display transition by switching the input signal for five luminance ratio (0%,25%,50%,75%,100% brightness matrix) and is based on  $F_{\nu}$ =60Hz to optimize.

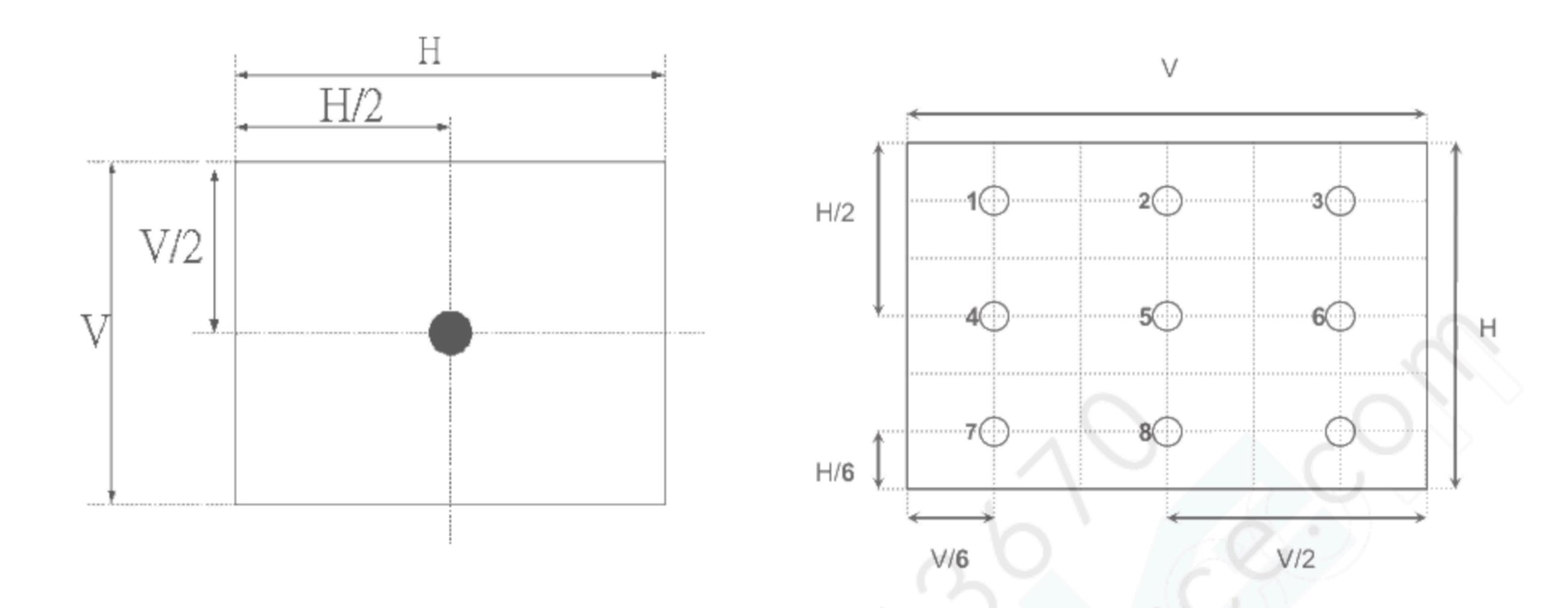
Me	asured	Target						
Respo	nse Time	0%	25%	50%	75%	100%		
	0%		0% to 25%	0% to 50%	0% to 75%	0% to 100%		
	25%	25% to 0%		25% to 50%	25% to 75%	25% to 100%		
044	50%	50% to 0%	50% to 25%		50% to 75%	50% to 100%		
Start	75%	75% to 0%	75% to 25%	75% to 50%		75% to 100%		
	100%	100% to 0%	100% to 25%	100% to 50%	100% to 75%			

 $T_{\gamma}$  is determined by 10% to 90% brightness difference of rising or falling period. (As illustrated) The response time is defined as the following figure and shall be measured by switching the input signal for "any level of gray(bright)" and "any level of gray(dark)".



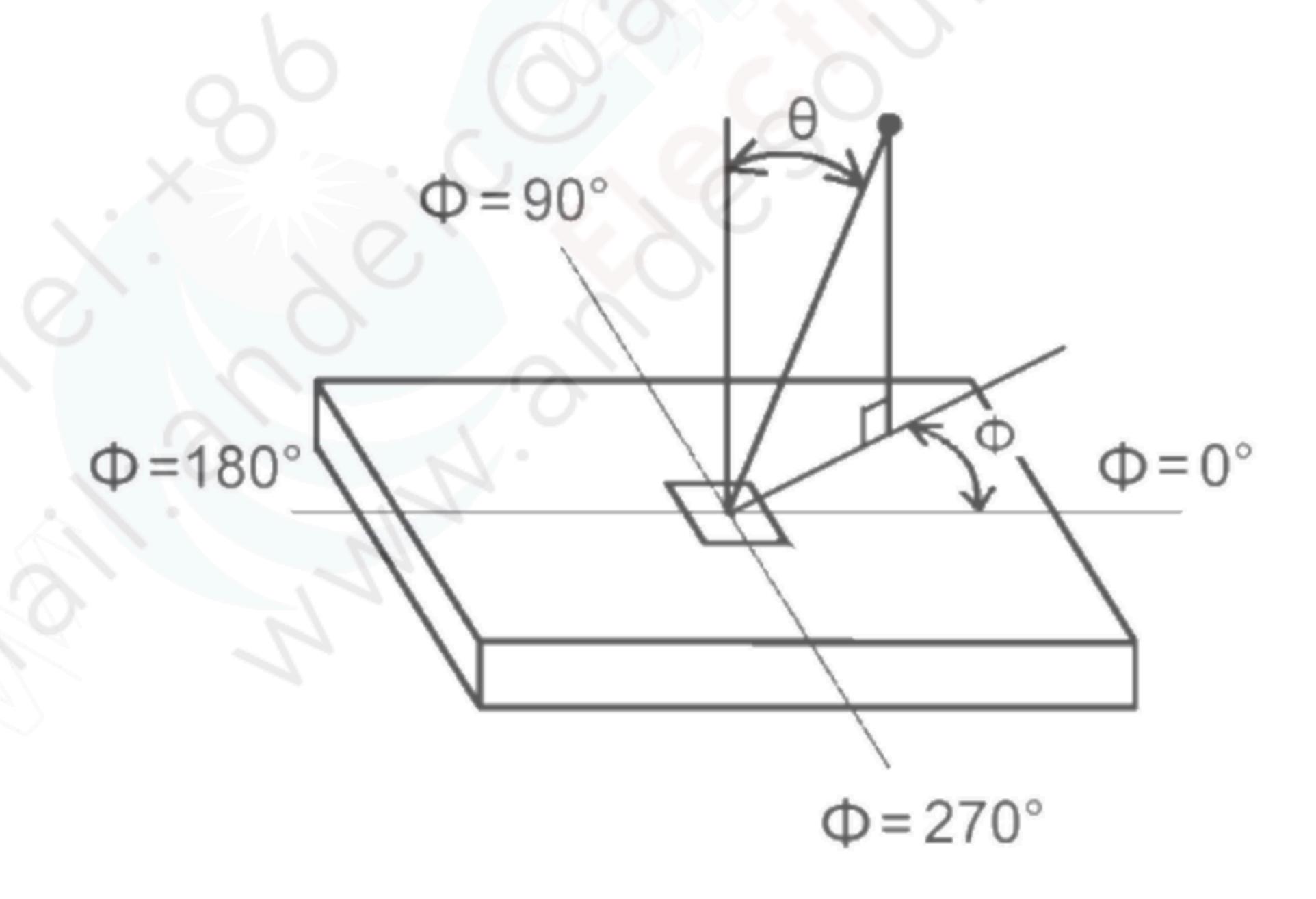


#### FIG. 2 Luminance



5. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG3.

#### FIG.3 Viewing Angle





#### 1.3. Mechanical Characteristics

The contents provide general mechanical characteristics for the model P430QVN02.0 In addition the figures in the next page are detailed mechanical drawing of the LCD.

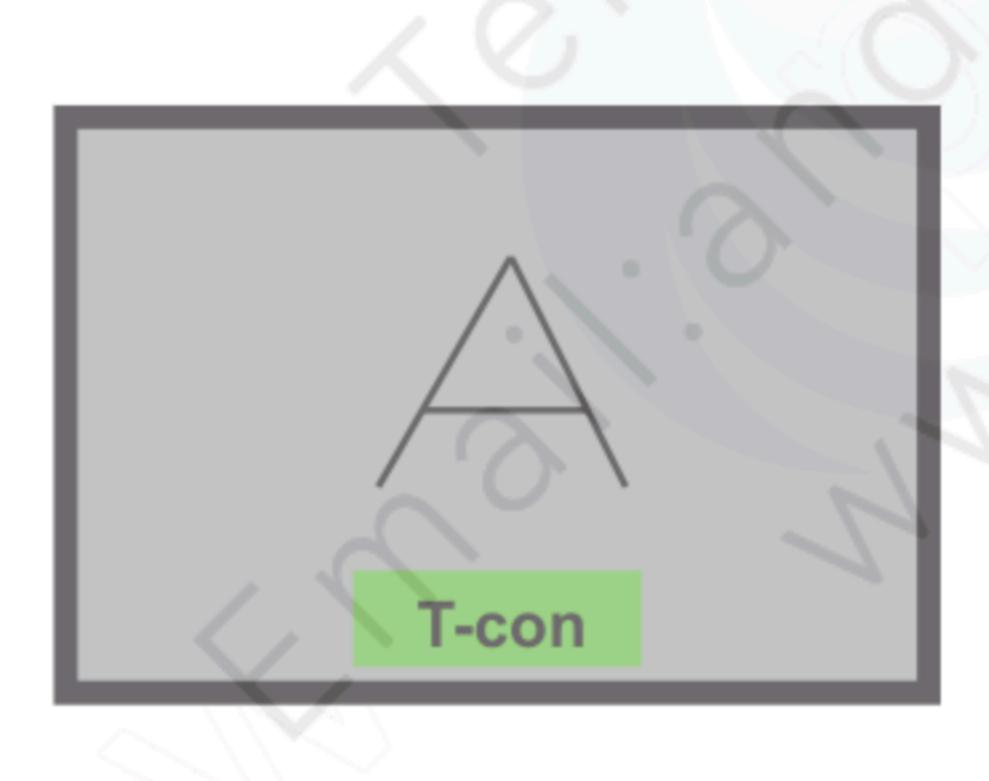
Item		Dimension	Unit	Note
	Horizontal	963.7 mm		
	Vertical	552.0 mm		
Outline Dimension	Depth (Dmin)	17.4	mm	front bezel to back bezel
	Depth (Dmax)	26.9	mm	to DB cover
Weight	106	40	G	w/ DB

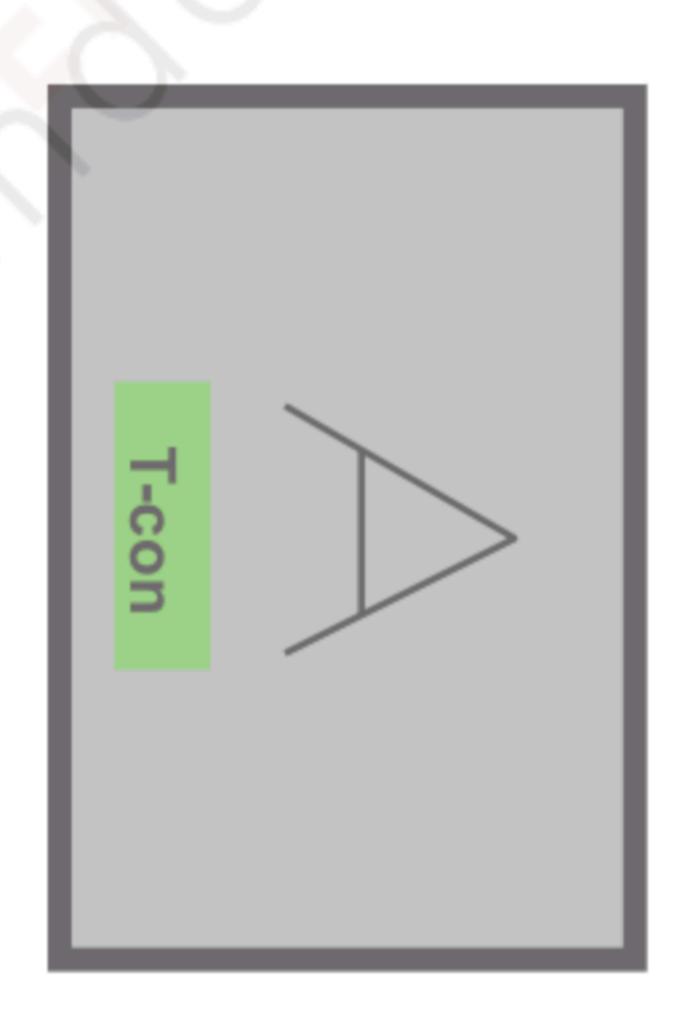
# 1.3.1. Placement Suggestions

- Landscape Mode: The default placement is T-Con Side on the lower side and the image is shown upright via viewing from the front.
- Portrait Mode: The default placement is that T-Con side has to be placed on the left side via viewing from the front.

Landscape (Front view)

Portrait (Front view)





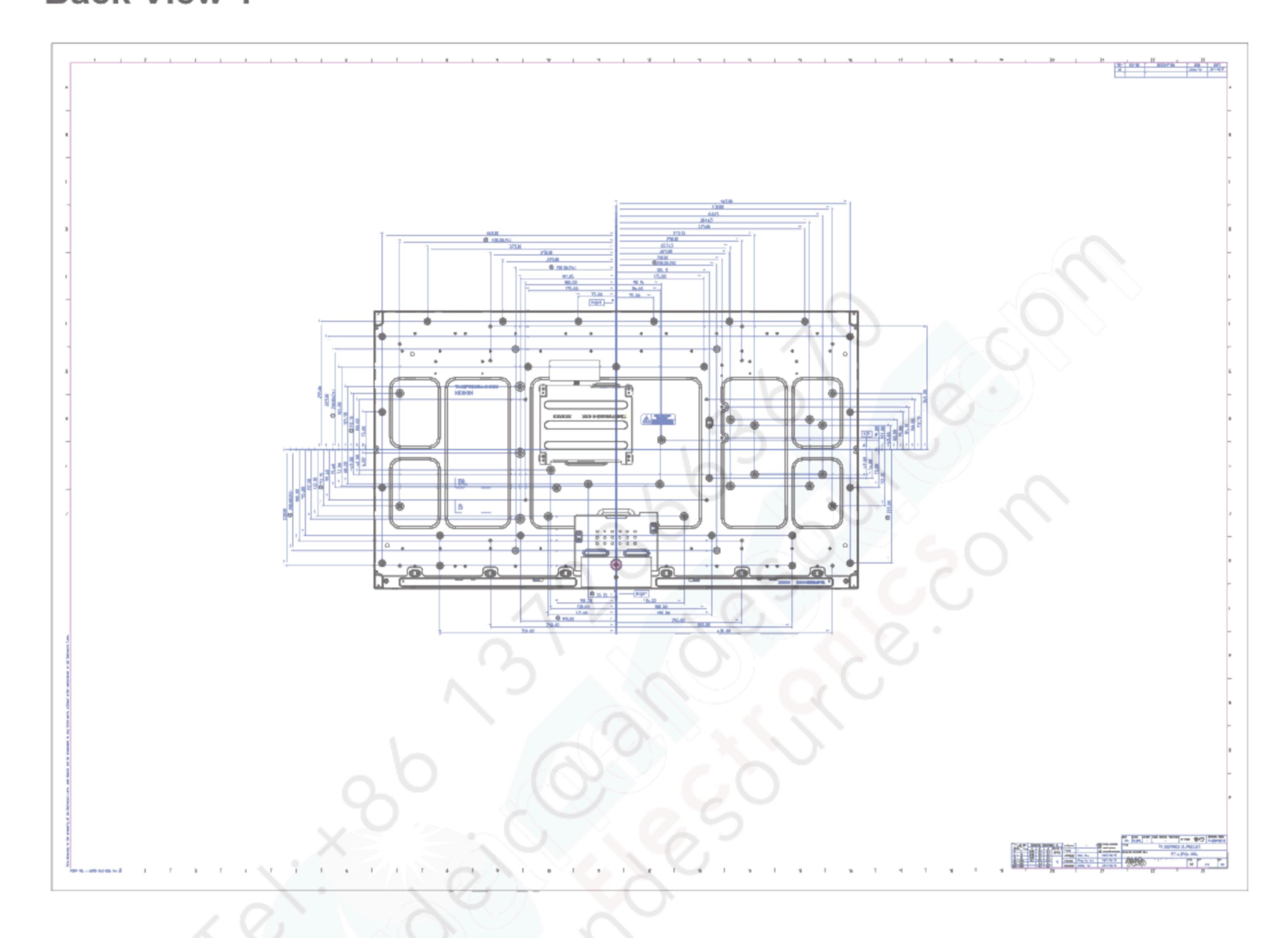


# **Front View**



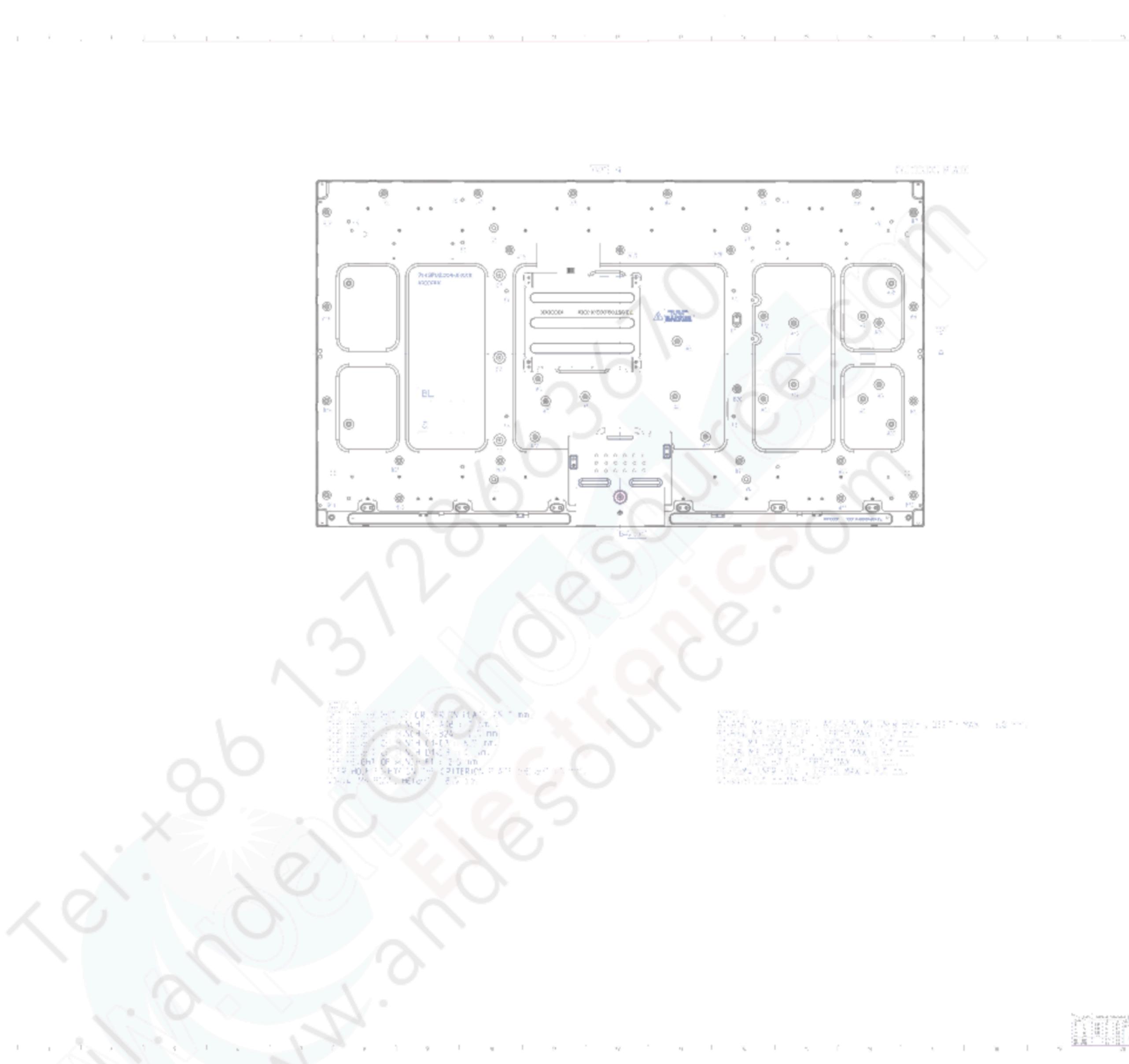


# Back View 1





# Back View 2





# 2. Absolute Maximum Ratings

The followings are maximum values which, if exceeded, may cause faulty operation or damage to the unit

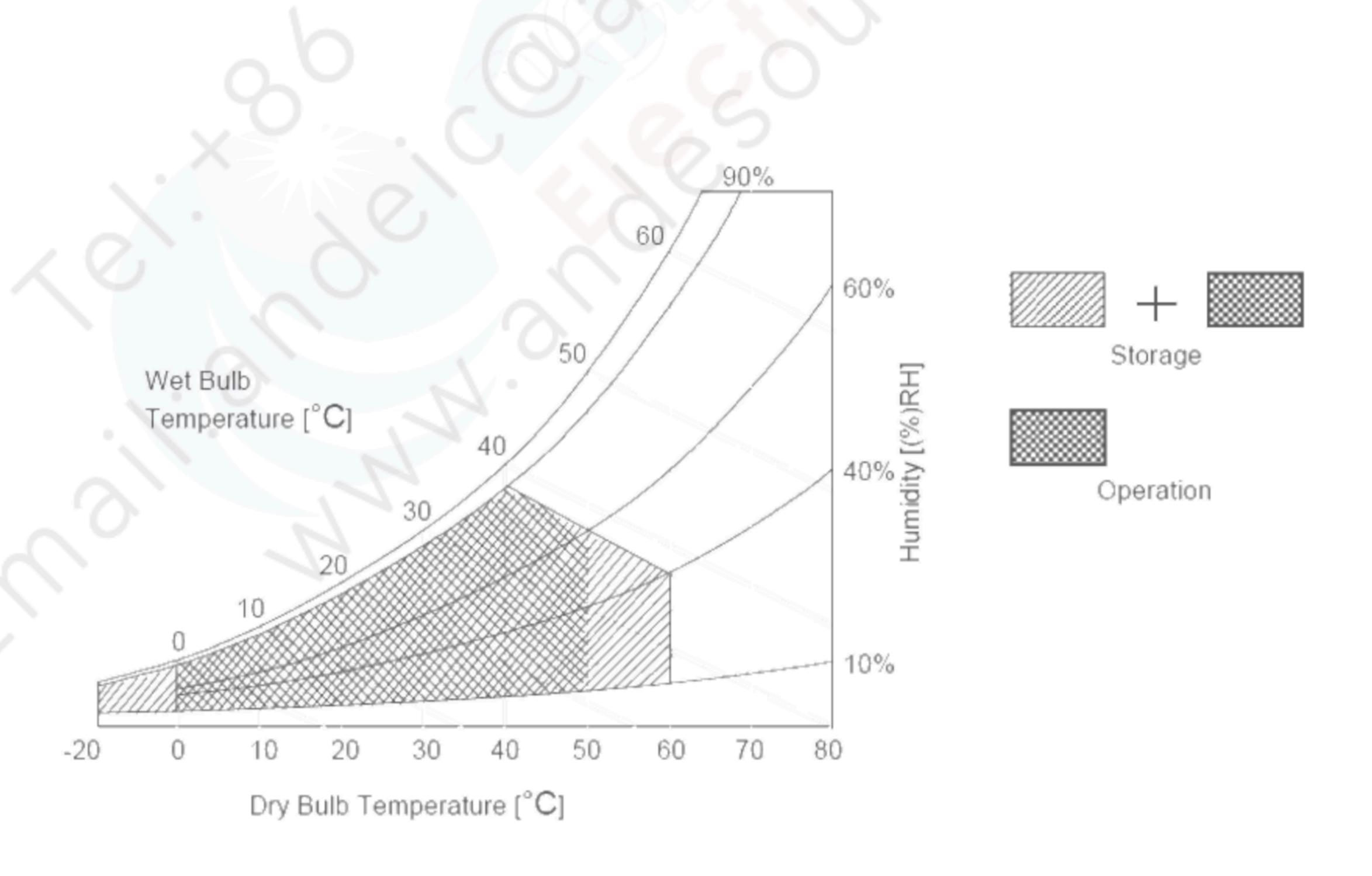
Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vcc	-0.3	14	[Volt]	Note 1
Input Voltage of Signal	Vin	-0.3	4	[Volt]	Note 1
Operating Temperature	TOP	0	+50	[°C]	Note 2
Operating Humidity	НОР	10	90	[%RH]	Note 2
Storage Temperature	TST	-20	+60	[°C]	Note 2
Storage Humidity	HST	10	90	[%RH]	Note 2
Panel Surface Temperature	PST		70	[°C]	Note 3

Note 1: Duration:50 msec.

Note 2: Maximum Wet-Bulb should be 39°C and No condensation.

The relative humidity must not exceed 90% non-condensing at temperatures of 40°C or less. At temperatures greater than 40°C, the wet bulb temperature must not exceed 39°C.

Note 3: Surface temperature is measured at 50℃ Dry condition





# 3. Electrical Specification

The P430QVN02.0 requires two power inputs. One is employed to power the LCD electronics and to drive the TFT array and liquid crystal. The other is to power Back Light Unit.

## 3.1. Electrical Characteristics

## 3.1.1. DC Characteristics (Ta = 25 $\pm$ 2 °C)

	Item		Symbol	Min.	Тур.	Max	Unit	
	LCD							
F	Power Supply Input	Voltage	V <sub>DD</sub>	10.8	12	13.2	V	1
		Black pattern		-	0.84	1.01	Α	
Power Sup	pply Input Current	White pattern	IDD	1 : 0	1.83	2.2	Α	
		H-Strip pattern			1.54	1.85	Α	_
		Black pattern	0-	<b>U</b> -	10.08	12.12	Watt	
Power	Consumption	White pattern	Pc	-	21.96	26.4	Watt	
		H-Strip pattern		X- (C)	18.45	22.2	Watt	
Inrush Curre	ent		I <sub>RUSH</sub>			5	Α	3
CMOS	Input High Thres	hold Voltage	V <sub>IH</sub> (High)	2.7		3.3	V <sub>DC</sub>	4
Interface	Input Low Thresh	old Voltage	(Low)	0		0.6	V <sub>DC</sub>	4
CML Different Threshold		nput High	VRTH	+50			mVDC	
V-by-one Interface	CML Differential I	Input Low	VRTL			-50	mVDC	
	CML Common m	ode Bias Voltage	VRCT	0.8	0.9	1.0	mVDC	



# 3.1.2. AC Characteristics (Ta = 25 $\pm$ 2 °C)

	Item	Symbol	Min.	Тур.	Max	Unit	Note
	VRXINP/N input each bit Period	T <sub>RRIP</sub> (UI)	250		625	ps	10bit 1
	Receiver Clock : Spread Spectrum Modulation range	Fclk_ss	Fclk -0.5%		Fclk +0.5%	MHz	2
	Receiver Clock : Spread Spectrum Modulation frequency	Fss			30	KHz	2
	CDR training pattern time	TLOCK		500	/	us	1
	Latency from LOCKN 'HIGH' to clock training pattern	L1	0	<u></u>		us	1
	Latency from LOCKN 'LOW' to normal 8b10b data	L2			70	us	1
	CML Differential Input High Threshold	V <sub>RTH</sub>	+50	6-1		mV <sub>DC</sub>	
	CML Differential Input Low Threshold	V <sub>RTL</sub>			-50	mV <sub>DC</sub>	
V-by-one	CML Common mode Bias Voltage	VRCT	-0.1	0	0.1	V <sub>DC</sub>	
Interface	Intra-pair skew	TINTRA	(C3)		0.3	UI	3
	Inter-pair skew	TINTER	2,//		380	UI	4
		A_X		0.25		UI	
		A_Y	/	0		mV	
		B_X		0.3		UI	
		B_Y		50		mV	
		C_X		0.7		UI	
		C_Y		50		mV	
		D_X		0.75		UI	
	Eye diagram at receiver	D_Y		0		mV	8
		E_X		0.7		UI	
		E_Y		-50		mV	
		F_X		0.3		UI	
		F_Y		-50		mV	

## 3.1.3. Driver Characteristics

Item	Symbol	Min	Max	Unit	condition
Driver Surface Temperature	DST		100	[°C]	Note

Note: Any point on the driver surface must be less than 100°C under any conditions.

#### 3.1.4. TCON Characteristics

Item	Symbol	Min	Max	Unit	condition
TCON Surface Temperature	TST		85	[°C]	Note

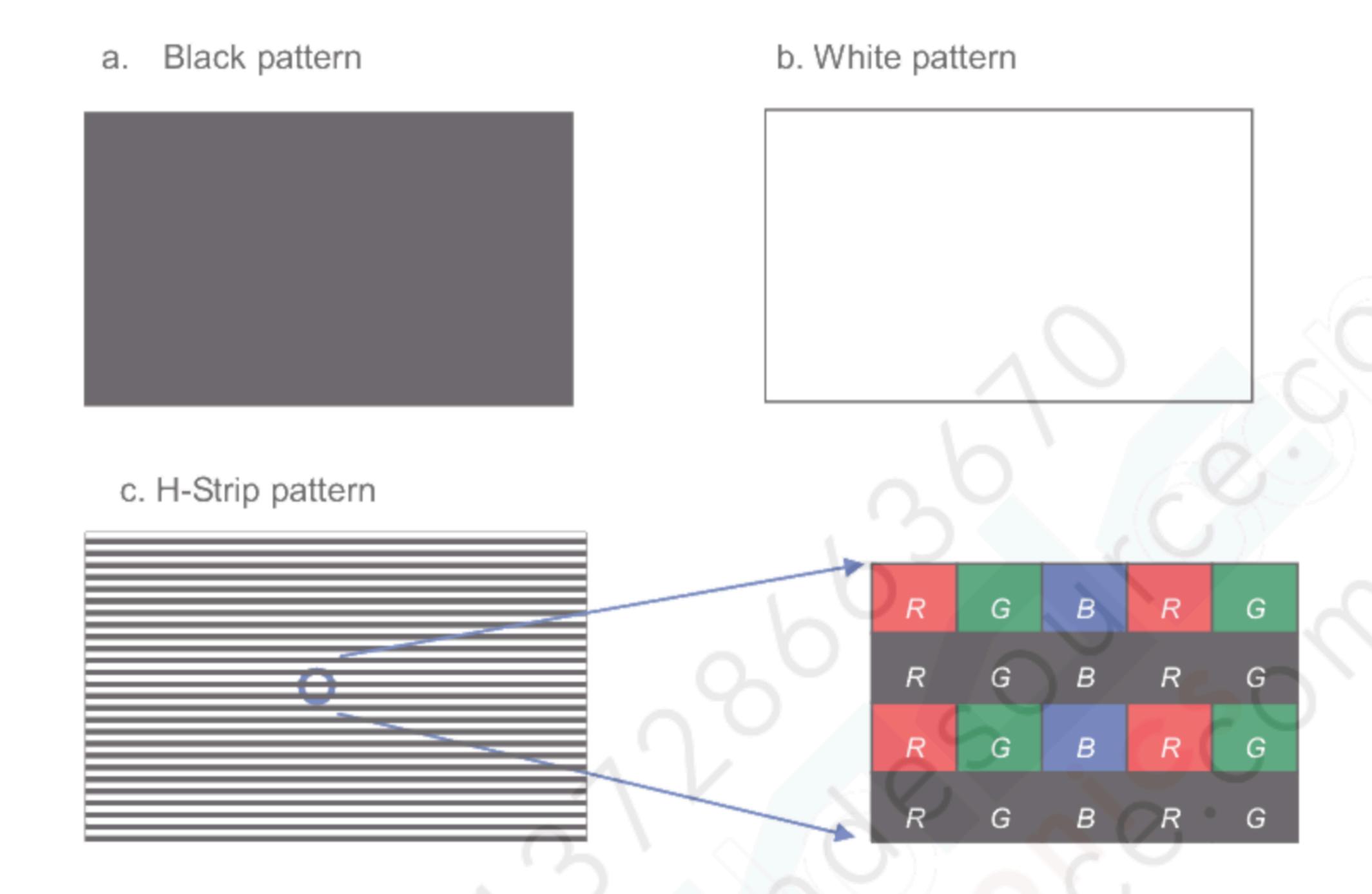
Note: Any point on the TCON surface must be less than 85°C under any conditions.



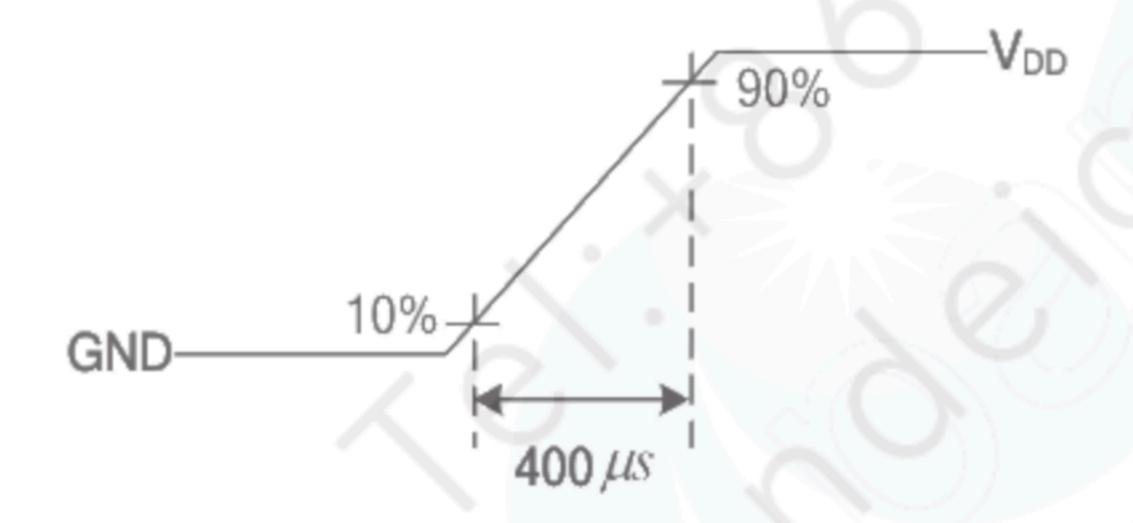
Note1. The ripple voltage should be fewer than 5% of VDD.

Note2. Test Condition:

- (1) V<sub>DD</sub> = 12.0V, (2) Fv = 60Hz, (3) Fclk= 74.25MHz, (4) Temperature = 25 °C
- (5) Power dissipation check pattern. (Only for power design)

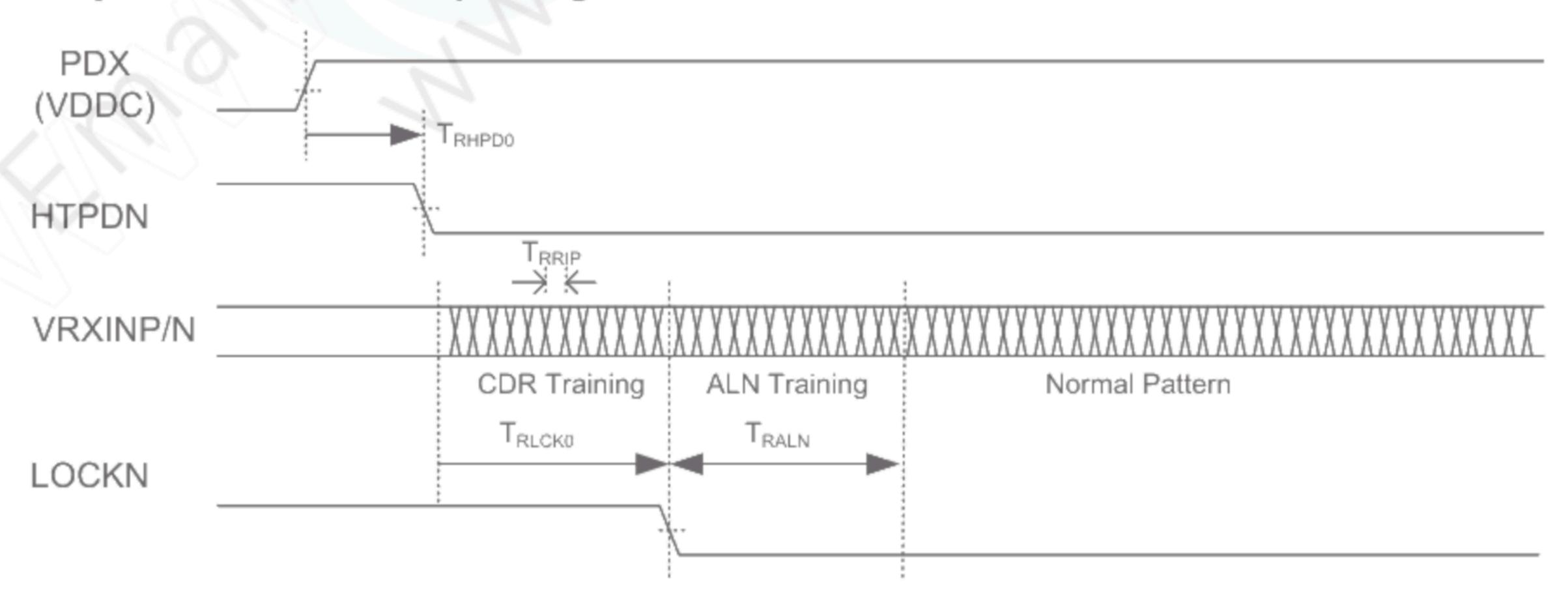


Note3. Measurement condition: Rising time = 400us



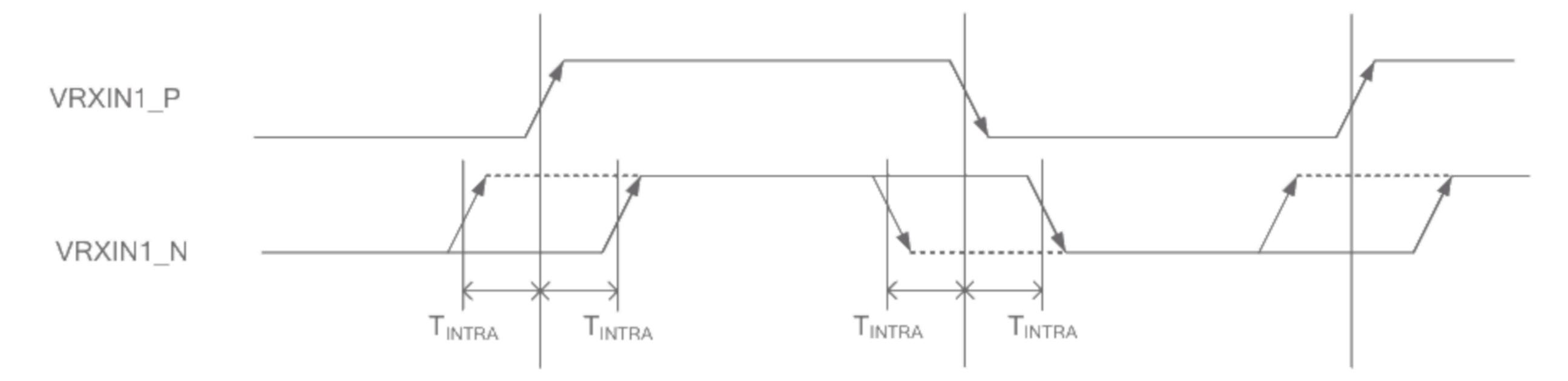
Note4. The measure points of VIH and VIL are in LCM side after connecting the System Board and LCM



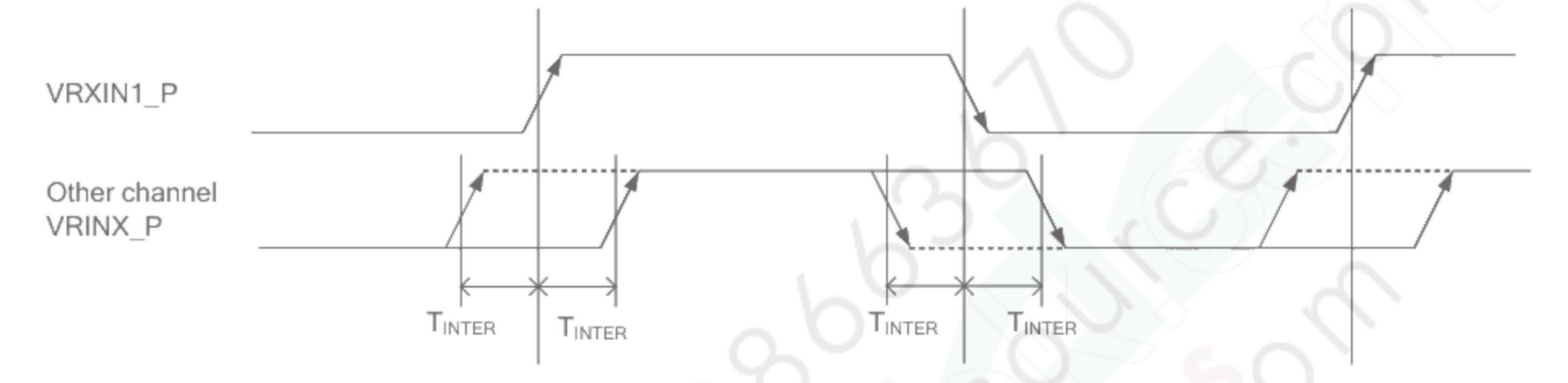


Note6. V-by-one Intra-pair Skew



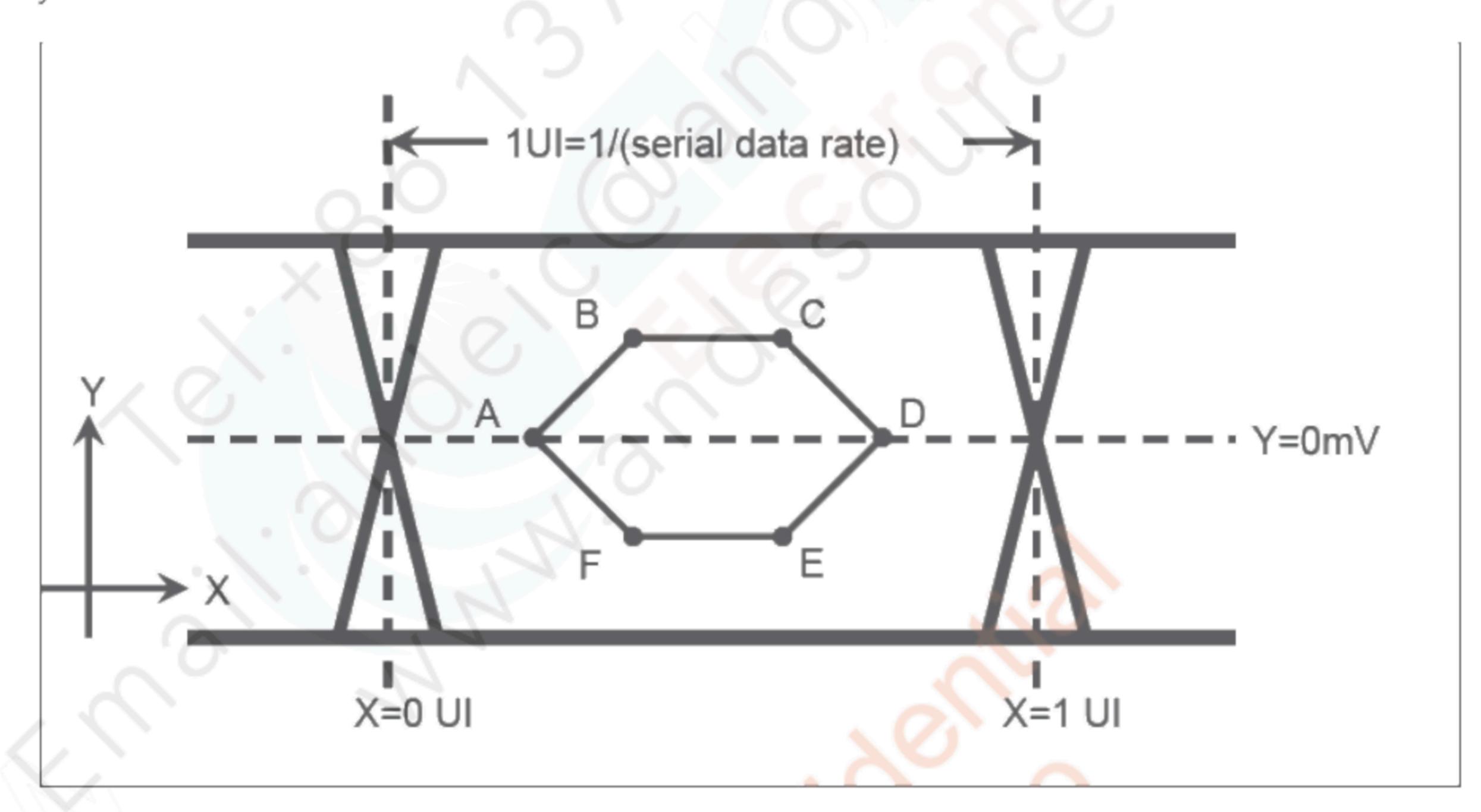


#### Note7. V-by-one Inter-pair Skew



Note8. Eye diagram at receiver

Eye Mask

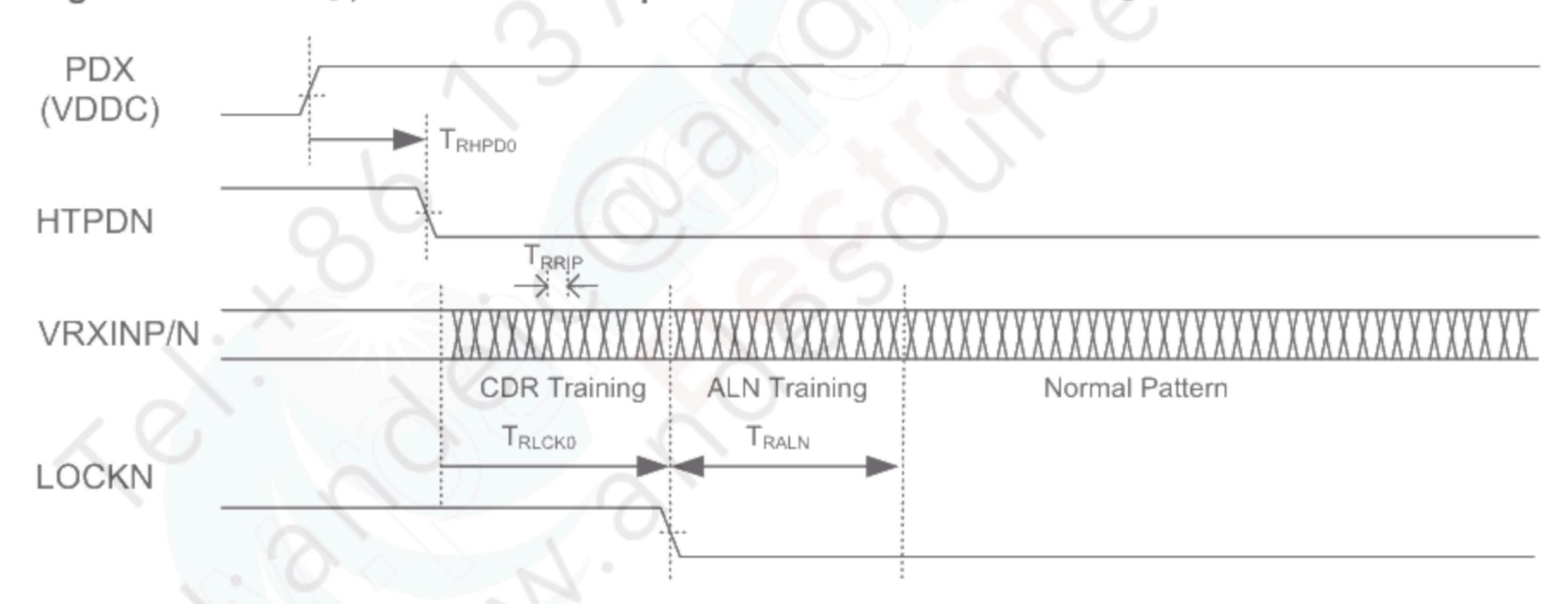


Example of Eye diagram





Note9. The relative humidity must not exceed 80% non-condensing at temperatures of 40℃ or less. At temperatures greater than 40℃, the wet bulb temperature must not exceed 39℃.





## 3.2. Interface Connections

LCD connector: JAE FI-RTE51SZ-HF (LVDS connector) or compatible

PIN	Symbol	Description
1	VIN	12V
2	VIN	12V
3	VIN	12V
4	VIN	12V
5	VIN	12V
6	VIN	12V
7	VIN	12V
8	VIN	12V
9	N.C.	No connection
10	GND	Ground
11	GND	Ground
12	GND	Ground
13	GND	Ground
14	GND	Ground
15	N.C.	No connection
16	N.C.	No connection
17	N.C.	No connection
18	N.C.	No connection
19	N.C.	No connection
20	N.C.	No connection
21	N.C.	No connection
22	N.C.	No connection
23	N.C.	No connection
24	GND	Ground
25	HTPDN	Vx1 HTPDN
26	LOCKN	Vx1 LOCK
27	GND	Ground
28	RX0N	Vx1 lane 0
29	RX0P	Vx1 lane 0
30	GND	Ground
31	RX1N	Vx1 lane 1
32	Rx1P	Vx1 lane 1
33	GND	Ground
34	RX2N	Vx1 lane 2



		Rev. 2.5
35	RX2P	Vx1 lane2
36	GND	Ground
37	RX3N	Vx1 lane 3
38	RX3P	Vx1 lane 3
39	GND	Ground
40	RX4N	Vx1 lane 4
41	RX4P	Vx1 lane 4
42	GND	Ground
43	RX5N	Vx1 lane 5
44	RX5P	Vx1 lane 5
45	GND	Ground
46	RX6N	Vx1 lane 6
47	RX6P	Vx1 lane 6
48	GND	Ground
49	RX7N	Vx1 lane 7
50	RX7P	Vx1 lane 7
51	GND	Ground



V by one color data mapping

or data mapping											
		Packer input	& Unpacker	30bpp RGB							
Mo	de		put	/YCbCr444							
				(10bit)							
			D[0]	R/Cr[2]							
			D[1]	R/Cr[3]							
			D[2]	R/Cr[4]							
		Byte0	D[3]	R/Cr[5]							
		Буцео	D[4]	R/Cr[6]							
			D[5]	R/Cr[7]							
			D[6]	R/Cr[8]							
			D[7]	R/Cr[9]							
			D[8]	G/Y[2]							
			D[9]	G/Y[3]							
	<u>e</u>		D[10]	G/Y[4]							
	mode	D. 4	D[11]	G/Y[5]							
	3byte r	Byte1	D[12]	G/Y[6]							
	3b		D[13]	G/Y[7]							
e	a		D[14]	G/Y[8]							
moc		80	D[15]	G/Y[9]							
4byte mode			D[16]	B/Cb[2]							
4 b				D[17]	B/Cb[3]						
	0					D[18]	B/Cb[4]				
			D[19]	B/Cb[5]							
		Byte2	D[20]	B/Cb[6]							
3			D[21]	B/Cb[7]							
	0		D[22]	B/Cb[8]							
			D[23]	B/Cb[9]							
			D[24]								
			D[25]								
			D[26]	B/Cb[0]							
			D[27]	B/Cb[1]							
		Byte3	D[28]	G/Y[0]							
			D[29]	G/Y[1]							
			D[30]	R/Cr[0]							
			D[31]								
			D[30]								



## 3.3. Signal Timing Specification

This is the signal timing required at the input of the user connector. All of the interface signal timing should be satisfied with the following specifications for its proper operation.

## Timing Table (DE only Mode)

Signal	ltem	Symbol	Min.	Тур.	Max	Unit
	Period	Tv	2200	2250	2715	Th
Vertical Section	Active	Tdisp (v)				
	Blanking	Tblk (v)	40	90	555	Th
	Period	Th	530	550	600	Tclk
Horizontal Section	Active	Tdisp (h)				
	Blanking	Tblk (h)	50	70	120	Tclk
Clock	Frequency	Fclk=1/Tclk	66	74.25	77	MHz
Vertical Frequency	Frequency	Fv	47	60	63	Hz
Horizontal Frequency	Frequency	Fh	120	135	139.2	KHz

#### Notes:

- (1) Display position is specific by the rise of DE signal only.

  Horizontal display position is specified by the rising edge of 1<sup>st</sup> DCLK after the rise of 1<sup>st</sup> DE, is displayed on the left edge of the screen.
- (2)Vertical display position is specified by the rise of DE after a "Low" level period equivalent to eight times of horizontal period. The 1<sup>st</sup> data corresponding to one horizontal line after the rise of 1<sup>st</sup> DE is displayed at the top line of screen.
- (3)If a period of DE "High" is less than 3840 DCLK or less than 2160 lines, the rest of the screen displays black.
- (4)The display position does not fit to the screen if a period of DE "High" and the effective data period do not synchronize with each other.



# 3.4. Color Input Data Reference

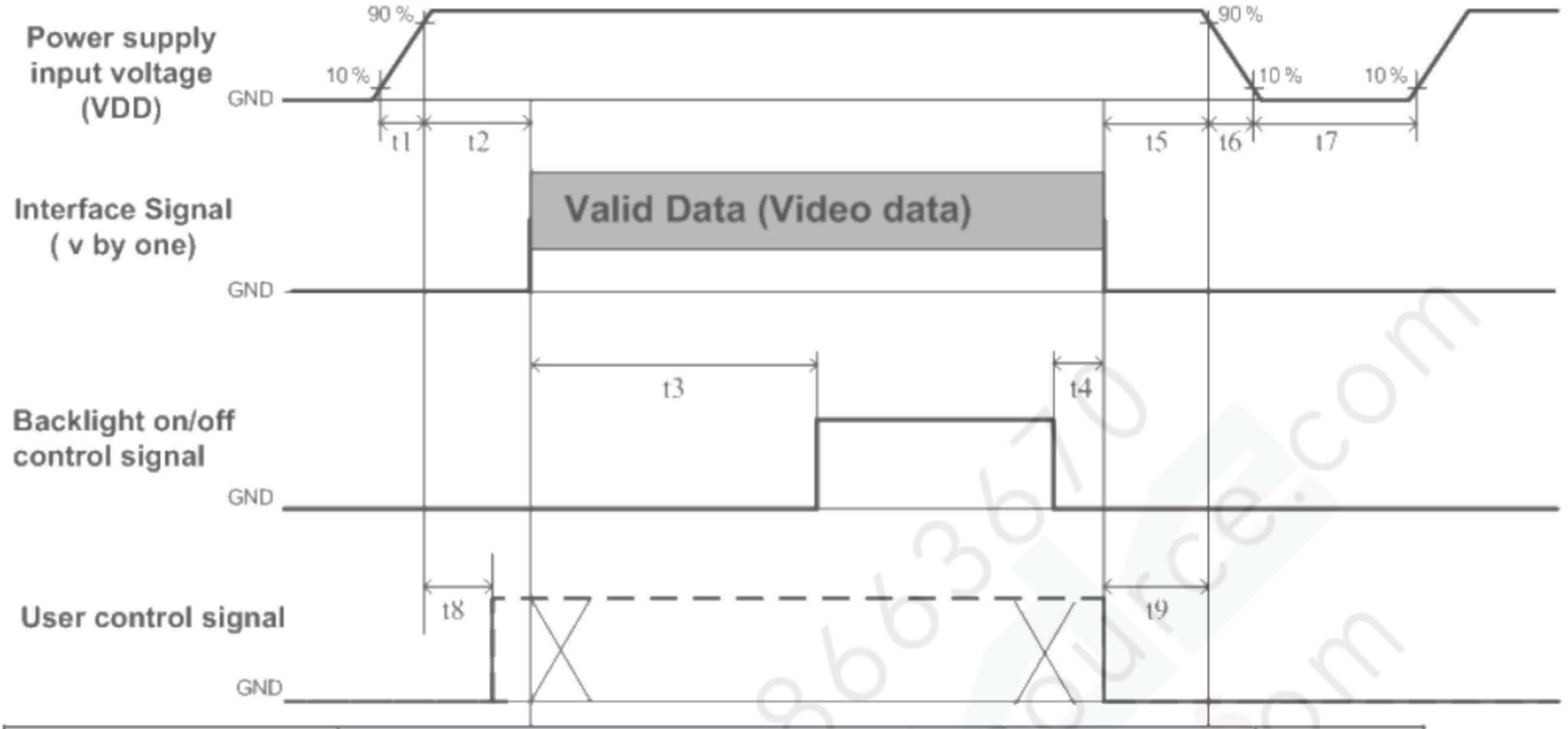
The brightness of each primary color (red, green, blue) is based on the 10 bit gray scale data input for the color; the higher the binary input, the brighter the color. The table below provides a reference for color versus data input.

#### COLOR DATA REFERENCE

														In	put	Col	or E	ata	l												
	0.1					RE	ΕD								(	GRE	EEN									BL	UE				
	Color	MS	BB							L	SB	MS	SB							LS	SB	MS	SB							L	SB
		R9	R8	R7	R6	R5	R4	R3	R2	R1	R0	G9	G8	G7	G6	G5	G4	G3	G2	G1	G0	В9	В8	В7	В6	B5	В4	ВЗ	B2	В1	ВО
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1023)	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1023)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0
	Blue(1023)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1
Color	Cyan	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	RED(000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED(001)	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R							V																								
	RED(1022)	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED(1023)	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(001)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
G												8																			
	GREEN(1022)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0
	GREEN(1023)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0
	BLUE(000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	BLUE(001)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
В																															
	BLUE(1022)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0
	BLUE(1023)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1



# 3.5. Power Sequence for LCD



Daramatar		Linit		
Parameter	Min.	Type.	Max.	Unit
t1	0.4		30	ms
t2	40			ms
t3	640			ms
t4	0*1			ms
t5	0			ms
t6			*2	ms
t7	1000			ms
t8	20*3	(0	50	ms
t9	0			ms

#### Note:

- (1) t4=0: concern for residual pattern before BLU turn off.
- (2) t6: voltage of VDD must decay smoothly after power-off. (customer system decide this value)
- (3) When user control signal is N.C. (no connection), opened in Transmitted end, t8 timing spec can be negligible.



## 3.6. Backlight Specification

## 3.6.1. Electrical specification (Ta = 25 $\pm$ 2 °C)

	I é o mo	Symbol		Condition		Spec		I I to i 6	Noto
	Item	Syli	IDOI	Condition	Min	Тур	Max	Unit	Note
1	Input Voltage	VD	DB	-	22.8	24	25.2	VDC	-
2	Input Current	I <sub>DI</sub>	DВ	VDDB=24V		5.43	5.86	ADC	1
3	Input Power	P <sub>DDB</sub>		VDDB=24V		130.2	140.6	W	1
4	Inrush Current	I <sub>RU</sub>	SH	VDDB=24V	1	-	8.3	ADC	2
	5 On/Off control voltage		ON	2.	3.3	5.5	5.5	LIDO	-
5		V <sub>BLON</sub>	OFF	0	0.8	0.8	0.8	VDC	-
6	On/Off control current	I <sub>BLON</sub>		VDDB=24V			1.5	mA	-
	External PWM		MAX	2	9	5.5	5.5		-
7	Control Voltage	V_EPWM	MIN	0		0.8	0.8	VDC	-
8	External PWM Control Current	I_EP	WM	VDDB=24V			2	mADC	-
9	External PWM Duty ratio	D_EF	NM	VDDB=24V	5	-	100	%	3
10	External PWM Frequency	F_EF	NM	VDDB=24V	120	180	960	Hz	-
44			HI	Open	Оре	en Colle	ctor	VDC	4
11	DET status signal	DET	Lo	Collector	0.8	0.8	0.8	VDC	4
12	Input Impedance	Ri	Rin		300			Kohm	-

Note 1: Dimming ratio= 100% (MAX) (Ta=25±5°C, Turn on for 45minutes)

Note 2: Measurement condition Rising time = 20ms (VDDB: 10%~90%);

Note 3: Less than 5% dimming control is functional well and no backlight shutdown happened

Note 4: Normal: 0~0.8V; Abnormal: Open collector



## 3.6.2. Input Pin Assignment

LED driver board connector: Cvilux Cl0114M1HR0-NH or compatible

Pin	Symbol	Description
1	VDDB	Operating Voltage Supply, +24V DC regulated
2	VDDB	Operating Voltage Supply, +24V DC regulated
3	VDDB	Operating Voltage Supply, +24V DC regulated
4	VDDB	Operating Voltage Supply, +24V DC regulated
5	VDDB	Operating Voltage Supply, +24V DC regulated
6	BLGND	Ground and Current Return
7	BLGND	Ground and Current Return
8	BLGND	Ground and Current Return
9	BLGND	Ground and Current Return
10	BLGND	Ground and Current Return
11	DET	BLU status detection:  Normal: 0~0.8V; Abnormal: Open collector  (Recommend Pull high R > 10K, VDD = 3.3V)
		BLU On-Off control:
12	VBLON	High/Open (2~5.5V) : BL On ; Low (0~0.8V/GND) : BL Off
13	NC	NC
14	PDIM(*)	External PWM (5%~100% Duty, open for 100%)



PWM Dimming: include Internal and External PWM Dimming

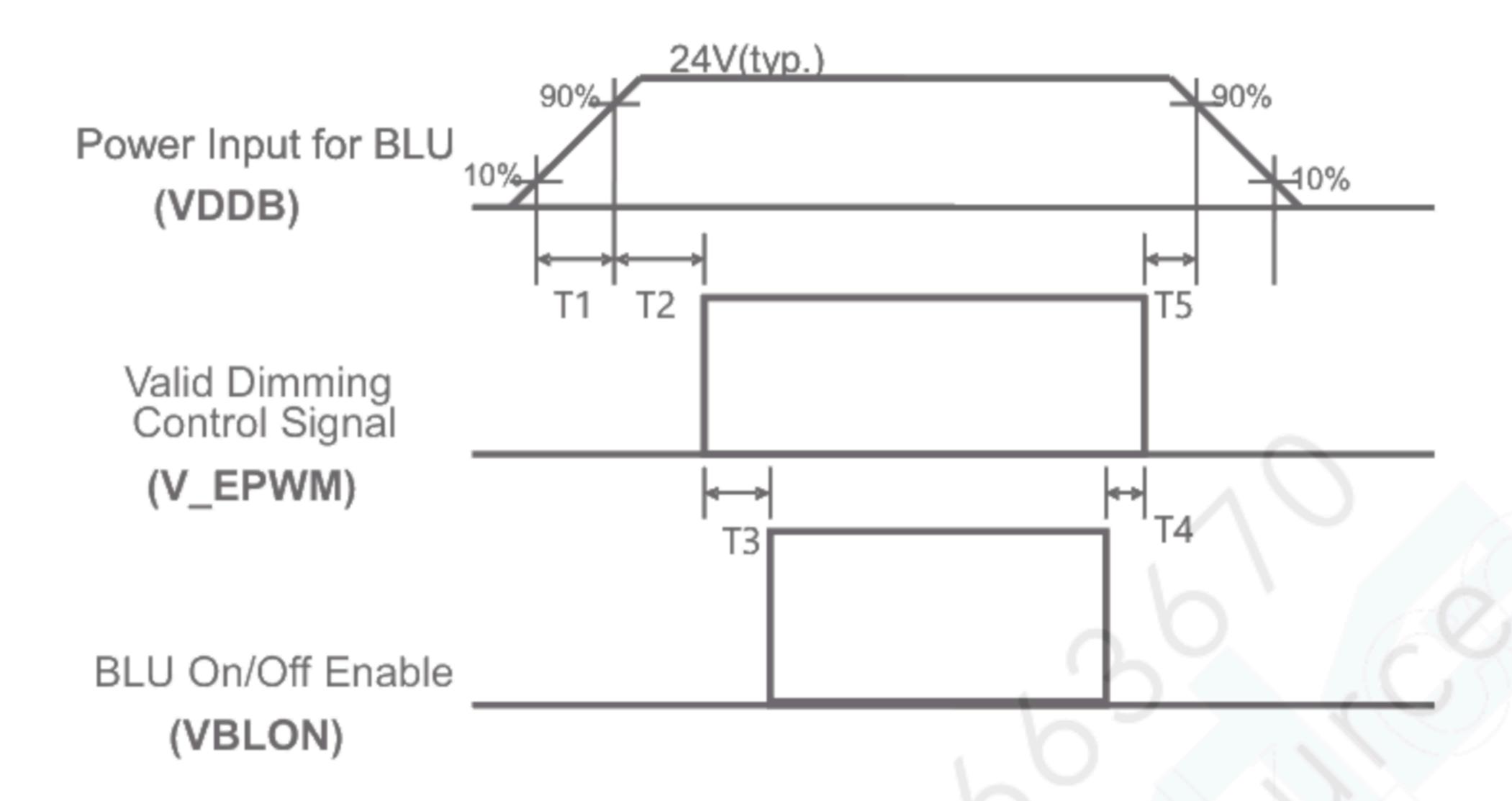
(Note\*) IF External PWM function includes 5% dimming ratio. Judge condition as below:

- (1) Backlight module must be lighted ON normally.
- (2) All protection function must work normally.

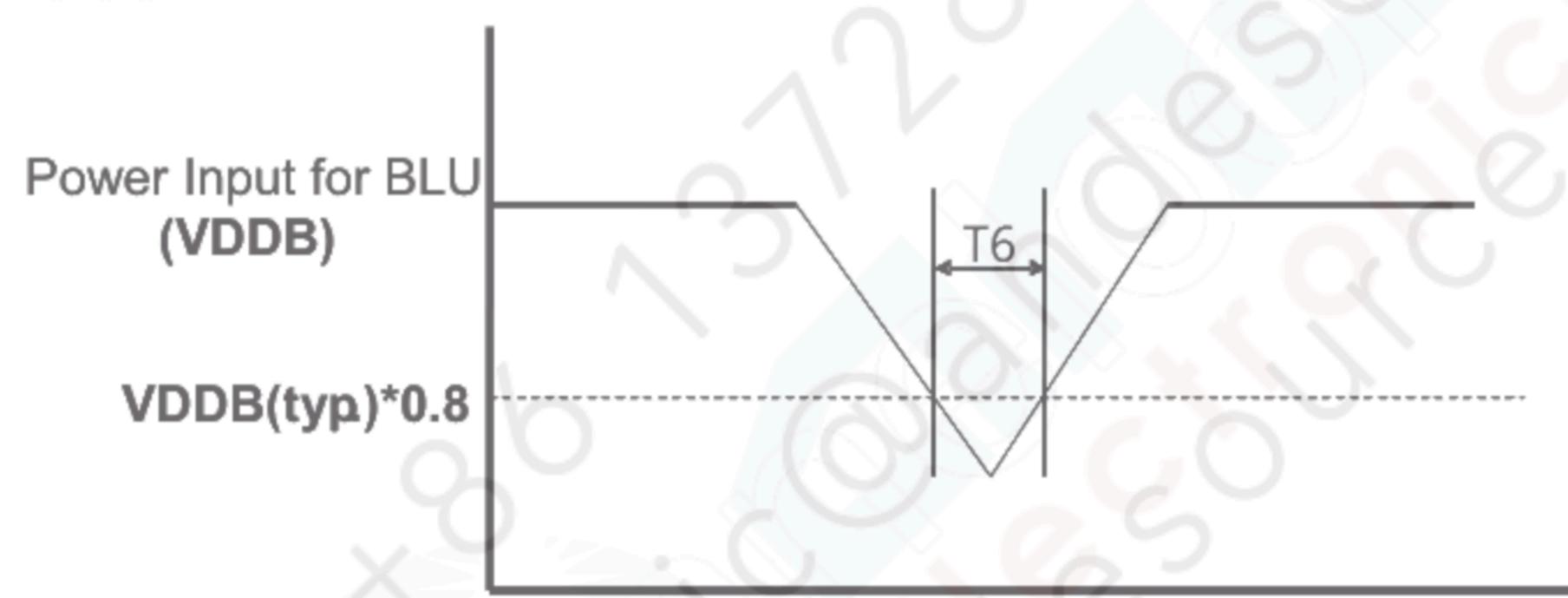
Uniformity and flicker could NOT be guaranteed



## 3.6.3. Power Sequence for Backlight



# Dip condition



45.00		11		
Parameter	Min	Тур	Max	Units
T1	20		_	ms
T2	250	_	_	ms
Т3	200			ms
T4	0	_	_	ms
T5	0	_	_	ms
Т6		_	1000	ms <sup>*1</sup>

Note: 1. T6 describes VDDB dip condition and VDDB couldn't lower than 10% VDDB.



# 3.6.4. LED Operating Life Time

Parameter	Symbol		Value	Unit	Note	
rarameter		Min.	Тур.	Max	Unit	Note
Backlight Operating Life Time(MTTF)		50000	60000		Hour	1

#### Note:

1. The lifetime (MTTF) is defined as the time which luminance of LED is 50% compared to its original value.

[Operating condition: Continuous operating at Ta = 25±2°C, for single lamp/LED only]



# 4. Reliability Test Items

	Test Item	Q'ty	Condition
1	High temperature storage test	3	60°С, 500hrs
2	Low temperature storage test	3	-20°C, 500hrs
3	High temperature operation test	3	50°С, 500hrs
4	Low temperature operation test	3	-5°С, 500hrs
5	Vibration test (non-operation)	3	Wave form: random Vibration level: 1.0G RMS Bandwidth: 10-300Hz Duration: X axis, Vertical, 10min Y axis, Vertical, 10min Z axis, Vertical, 10min one time each direction
6	Shock test (non-operation)	3	Shock level 50G ,11ms ±X,Y,Z axis Waveform: half sine wave Direction: One time each direction
7	Vibration test (With carton)	1CTN/10PCS	Random wave (1.04Grms 2~200Hz)  Duration: X,Y,Z 20min per axes
8	Drop test (With carton)	1CTN/10PCS	Height: 254 cm Front>Back>Left>Right>Top>Bottom / 2 <sup>nd</sup> time



# 5. International Standard

# 5.1. Safety

- (1) UL 60950-1; Standard for Safety of Information Technology Equipment Including electrical Business Equipment.
- (2) IEC 60950-1; Standard for Safety of International Electrotechnical Commission
- (3) EN 60950-1; European Committee for Electrotechnical Standardization (CENELEC), EUROPEAN STANDARD for Safety of Information Technology Equipment Including Electrical Business Equipment.

# 5.2. EMC

- (1) ANSI C63.4 "Methods of Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electrical Equipment in the Range of 9kHz to 40GHz. "American National standards Institute(ANSI), 1992
- (2) C.I.S.P.R "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." International Special committee on Radio Interference.
- (3) EN 55022 "Limits and Methods of Measurement of Radio Interface Characteristics of Information
  - Technology Equipment." European Committee for Electrotechnical Standardization. (CENELEC), 1998

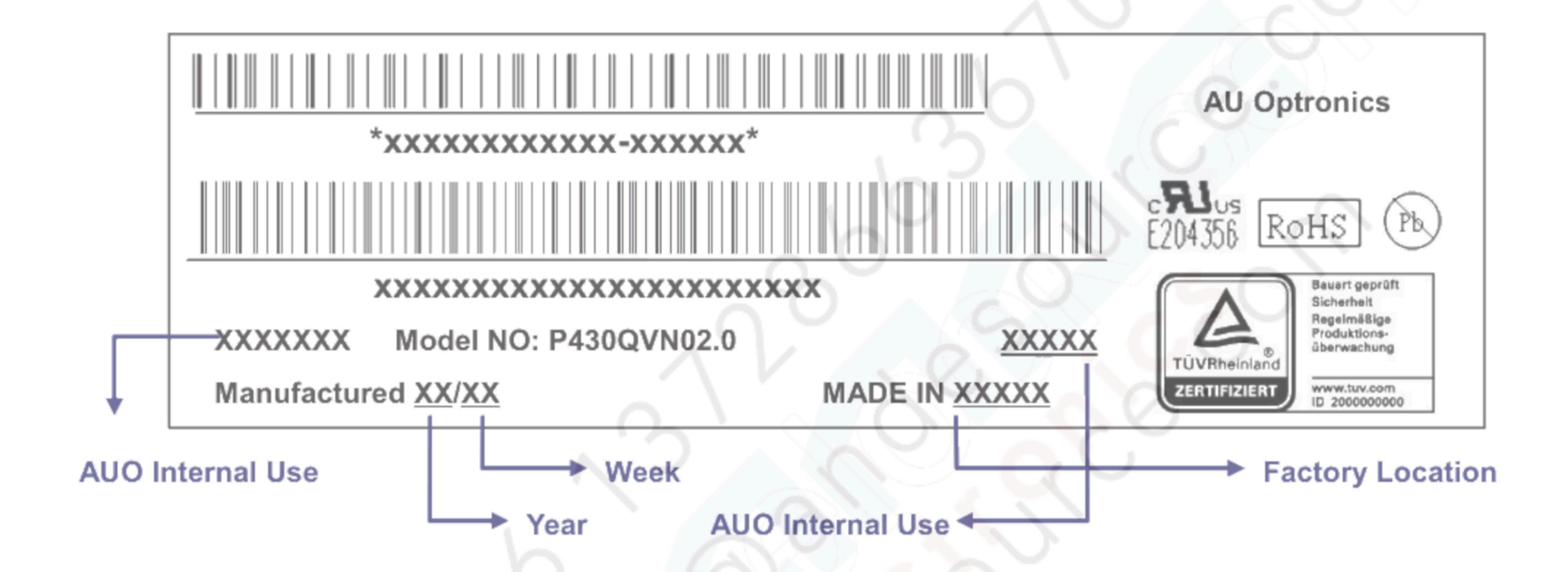


# 6. Packing

# 6.1. Definition of Label

#### A. Panel Label:





#### Green mark description

- (1) For Pb Free Product, AUO will add (Pb) for identification.
- (2) For RoHs compatible products, AUO will add RoHS for identification.

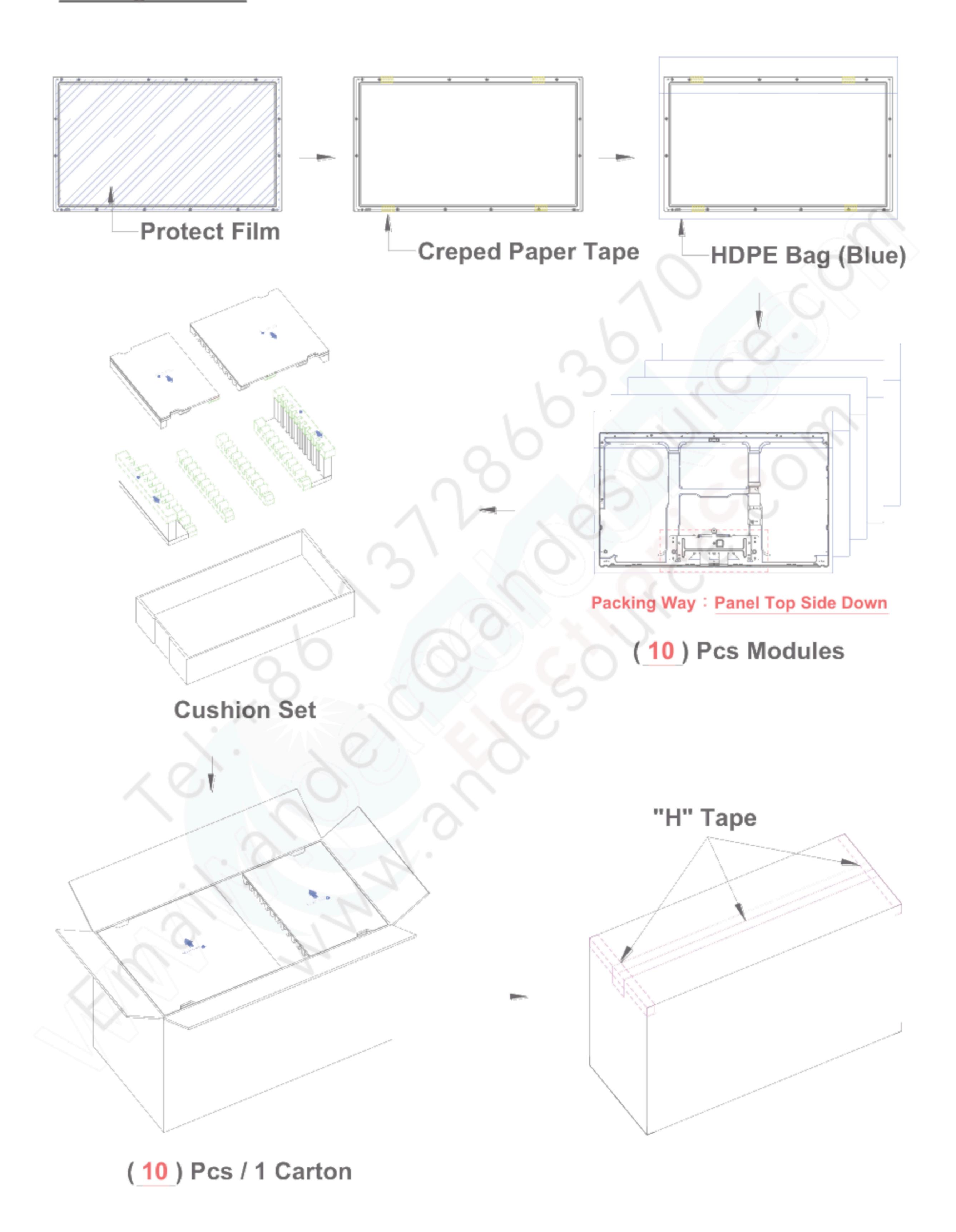
Note: The green Mark will be present only when the green documents have been ready by AUO internal green team. (definition of green design follows the AUO green design checklist.)

### B. Carton Label:





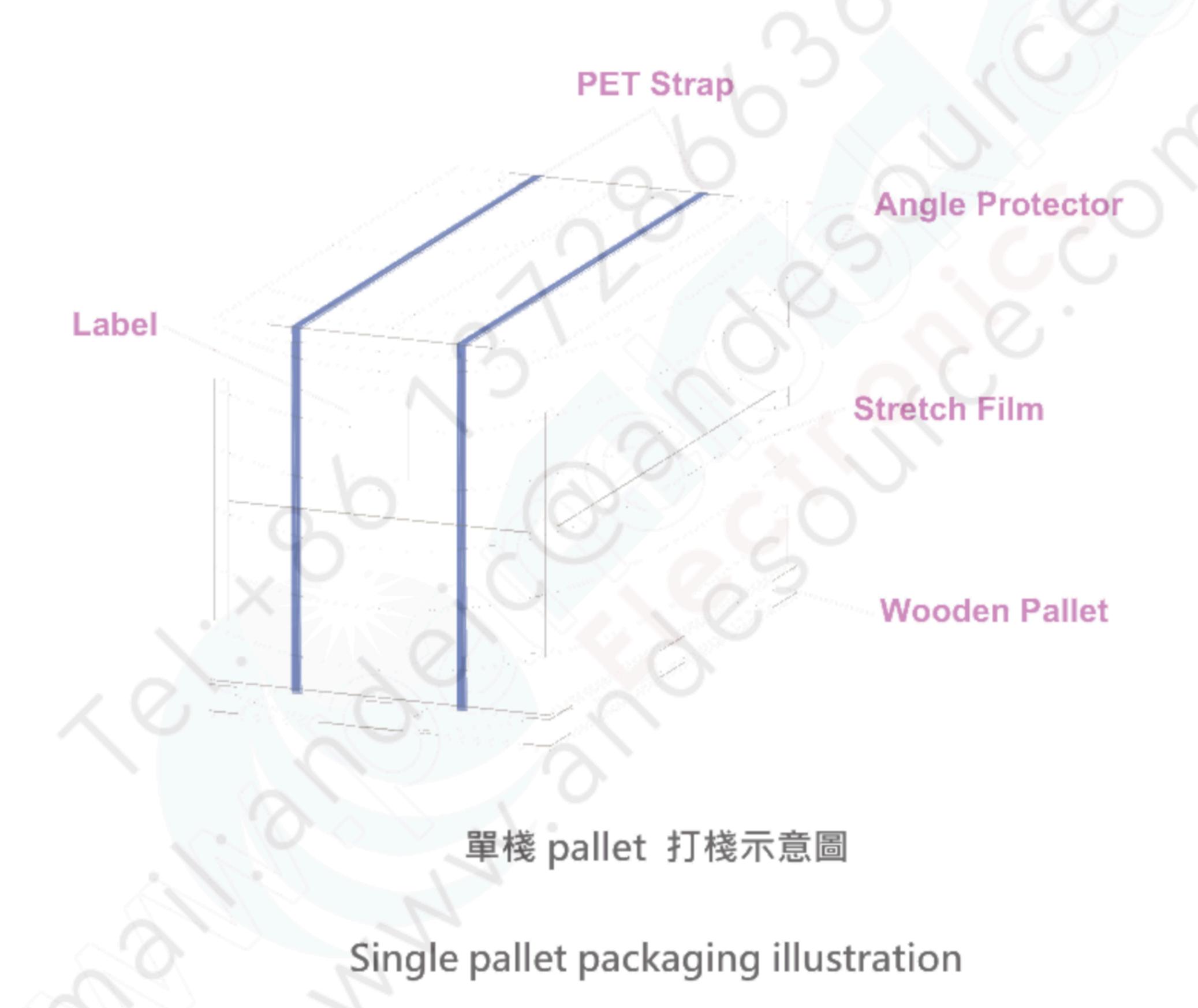
# 6.2. Packing Methods





# 6.3. Pallet and Shipment Information

	I to ma		Dooking Domork		
	Item	Qty. Dimension		Weight (kg)	Packing Remark
1	Packing Box	10 pcs/box	1060(L)*560(W)*635(H)	109.7	Packing:4660g
2	Pallet	1	1150(L)*1070(W)*132(H)	15.6	
3	Boxes per Pallet		2 boxes/pallet		
4	Panels per Pallet				
5	Pallet after packing	20	1150(L)*1070(W)*1402(H)	235	





# 7. Precautions

Please pay attention to the followings when you use this TFT LCD module.

# 7.1. Mounting Precautions

- (1) You must mount a module using holes arranged in four corners or four sides.
- (2) You should consider the mounting structure so that uneven force (ex. twisted stress) is not applied to module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter cause circuit broken by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizer with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth. (Some cosmetics are detrimental to the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front/ rear polarizer. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.

#### 7.2. Operating Precautions

- (1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage: V=±200mV(Over and under shoot voltage)
- (2) Response time depends on the temperature. (In lower temperature, it becomes longer..)
- (3) Brightness depends on the temperature. (In lower temperature, it may become lower.) And in lower temperature, response time (required time that brightness is stable after turned on) becomes longer.
- (4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (6) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may



be important to minimize the interface.

## 7.3. Operating Condition for Public Information Display

The device listed in the product specification is designed and manufactured for PID (Public Information Display) application. To optimize module's lifetime and function, below operating usages are required.

- (1) Normal operating condition
  - A. Operating temperature: 0~50°C
  - B. Operating humidity: 10~90%
  - C. Display pattern: dynamic pattern (Real display).

    Note) Long-term static display would cause image sticking.
- (2) Operation usage to protect against image sticking due to long-term static display.
  - A. Suitable operating time: 24 hours a day or less.
    - (\* The moving picture can be allowed for 24 hours a day)
  - B. Liquid Crystal refresh time is required. Cycling display between 5 minutes' information (static) display and 10 seconds' moving image.
  - C. Periodically change background and character (image) color.
  - D. Avoid combination of background and character with large different luminance.
- (3) Periodically adopt one of the following actions after long time display.
  - A. Running the screen saver (motion picture or black pattern)
  - B. Power off the system for a while
- (4) LCD system is required to place in well-ventilated environment. Adapting active cooling system is highly recommended.
- (5) Product reliability and functions are only guaranteed when the product is used under right operation usages. If product will be used in extreme conditions, such as high temperature/ humidity, display stationary patterns, or long operation time etc..., it is strongly recommended to contact AUO for filed application engineering advice. Otherwise, its reliability and function may not be guaranteed. Extreme conditions are commonly found at airports, transit stations, banks, stock market and controlling systems.

## 7.4. Electrostatic Discharge Control

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wristband etc. And don't touch interface pin directly.

#### 7.5. Precautions for Strong Light Exposure

- (1) Strong light exposure causes degradation of polarizer and color filter.
- (2) To keep display functional well as a digital signage application, especially the component of TFT is very sensitive with sunlight, it is necessary to set up blocking device protecting panel from radiation of ambient environment.



## 7.6. Storage

When storing modules as spares for a long time, the following precautions are necessary.

- (1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5℃ and 35℃ at normal humidity.
- (2) The polarizer surface should not come in contact with any other object. It is recommended that they be stored in the container in which they were shipped.
- (3) Storage condition is guaranteed under packing conditions.
- (4) The phase transition of Liquid Crystal in the condition of the low or high storage temperature will be recovered when the LCD module returns to the normal condition.

#### 7.7. Handling Precautions for Protection Film

- (1) The protection film is attached to the bezel with a small masking tape. When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
- (2) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the bezel after the protection film is peeled off.
- (3) You can remove the glue easily. When the glue remains on the bezel or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.